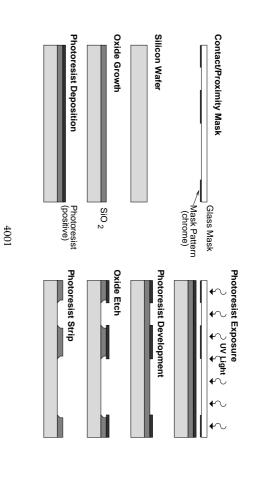
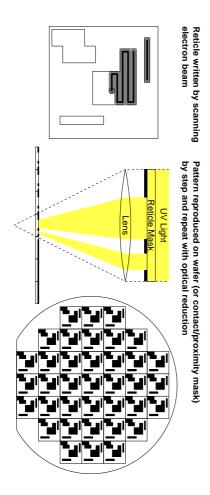
### Photolithography



#### Mask Making

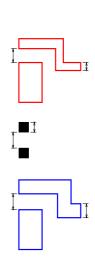


Optical reduction allows narrower line widths.

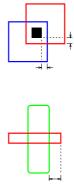
#### Design Rules

To prevent chip failure, designs must conform to design rules:

Single layer rules

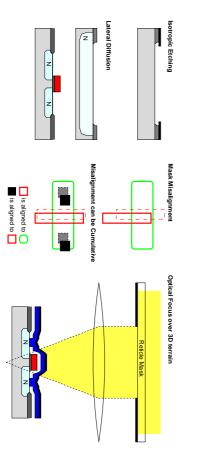


Multi-layer rules

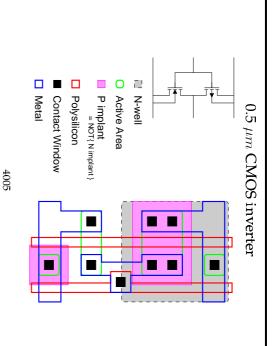


4003

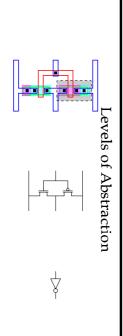
# Derivation of Design Rules



#### Design Rules

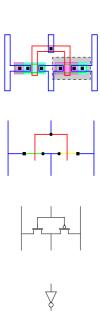


#### Abstraction



- Mask Level Design
- Laborious Technology/Process dependent.
- -Design rules may change during a design!
- Transistor Level Design
- Process independent, Technology dependent.
- Gate Level Design
- $-Process/Technology\ independent.$

# Abstraction - Stick Diagrams



Stick diagrams give us many of the benefits of abstraction:

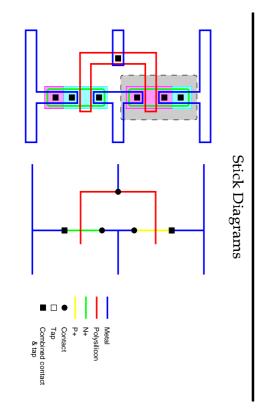
- Much easier/faster than full mask specification.
- Process independent (valid for any CMOS process)
- Easy to change.

while avoiding some of the problems:

 Optimized layout may be generated much more easily from a stick diagram than from transistor or gate level designs.<sup>1</sup>

4007

## Digital CMOS Design

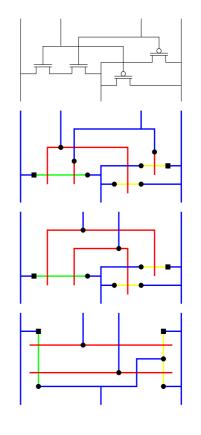


4006

<sup>&</sup>lt;sup>1</sup>note that all IC designs must end at the mask level.

## Digital CMOS Design

### Stick Diagrams



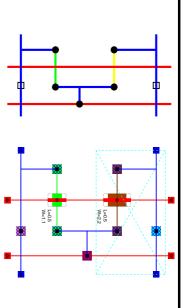
4009

## Digital CMOS Design

### Stick Diagrams

- Explore your Design Space.
- Implications of crossovers.
- Number of contacts.
- Arrangement of devices and connections.
- Process independent layout.
- Easy to expand to a full layout for a particular process.

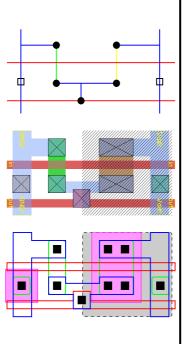
Sticks and CAD - Symbolic Capture



- Transistors are placed and explicitly sized.
- components are joined with zero width wires.
- contacts are automatically selected as required.
- A semi-automatic compaction process will create DRC correct layout.

4011

# Sticks and CAD - Magic



- Log style design (sticks with width) DRC errors are flagged immediately.
  again contacts are automatically selected as required.
- On-line DRC leads to rapid generation of correct designs.
  symbolic capture style compaction is available if desired.